

LISTING OF THE CLAIMS:

This listing of claims will replace all prior versions and listings of claims in the application:

1. (Original) An arrangement including:
an electrical subassembly,
an optical subassembly,
said electrical subassembly and said optical subassembly having an associated electrical connection including at least one electrical lead extending therebetween, and
at least electrically non-conductive absorber body arranged to at least partly cover said at least one electrical lead.
2. (Currently amended) The arrangement of claim 1, wherein said associated electrical connection includes a lead frame comprising a plurality of said at least one electrical leads, said absorber body arranged to extend over said lead frame.
3. (Currently amended) ~~The arrangement of claim 1, further including~~ An arrangement including:
an electrical subassembly,
an optical subassembly,
said electrical subassembly and said optical subassembly having an associated
electrical connection including at least one electrical lead extending therebetween,
at least electrically non-conductive absorber body arranged to at least partly
cover said at least one electrical lead, and
a dielectric support board, wherein said electrical connection extends over said support board and said at least one electrical lead is arranged between said absorber body and said support board.

4. (Currently amended) The arrangement of claim 3, including at least one further electrically non-conductive electromagnetic absorber body associated with said supporting board, wherein said at least one electrical lead is sandwiched between said at least electrically non-conductive [[one]] absorber body and said at least one further electrically non-conductive electromagnetic absorber body.

5. (Cancelled).

6. (Currently amended) ~~The arrangement of claim 1, including~~ An arrangement including:

an electrical subassembly,

an optical subassembly,

said electrical subassembly and said optical subassembly having an associated electrical connection including at least one electrical lead extending therebetween

at least electrically non-conductive absorber body arranged to at least partly cover said at least one electrical lead, and

a further optical subassembly and a further electrical connection between said electrical subassembly and said further optical subassembly, said further electrical connection including at least one further electrical lead, the arrangement including at least one further electrically non-conductive electromagnetic absorber body arranged to at least partly cover said at least one further electrical lead.

7. (Original) The arrangement of claim 1, wherein said absorber body is selected out of the group consisting of magnetically loaded, iron loaded, ferrite loaded or dielectrically loaded materials.

8. (Original) The arrangement of claim 1, wherein said absorber body is comprised of a material selected from the group consisting of silicon, urethane, vinyl plastic and silicon rubber.

9. (Original) The arrangement of claim 1, wherein said absorber body is in the form of a sheet material.

Claims 10 – 24. (Cancelled)